



DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below adjacent to my name.

I believe I am an original, first and joint inventor of subject matter (process, machine, manufacture, or composition of matter, or an improvement thereof) which is claimed and for which a patent is sought by way of the application entitled

**SENSOR POSITIONING SYSTEMS AND METHODS**

which was filed on **October 16, 2003** as Application Serial No. **10/688,300**.

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims.

I acknowledge the duty to disclose information, which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I declare that all statements made herein of my own knowledge are true, all statements made herein on information and belief are believed to be true, and all statements made herein are made with the knowledge that whoever, in any matter within the jurisdiction of the Patent and Trademark Office, knowingly and willfully falsifies, conceals, or covers up by any trick, scheme, or device a material fact, or makes any false, fictitious or fraudulent statements or representations, or makes or uses any false writing or document knowing the same to contain any false, fictitious or fraudulent statement or entry, shall be subject to the penalties including fine or imprisonment or both as set forth under 18 U.S.C. 1001, and that violations of this paragraph may jeopardize the validity of the application or this document, or the validity or enforceability of any patent, trademark registration, or certificate resulting therefrom.

Full name of joint inventor: Mei H. Sun

Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Residence: 1059 Eastwood Drive

Los Altos, CA 94024

Post Office Address: same as above

Citizenship: USA

Full name of joint inventor: Richard Schwaninger

Inventor's Signature: Richard Schwaninger Date: March 10 2004

Residence: 5080 Rigatti Circle

Pleasanton, CA 94588

Post Office Address: same as above

Citizenship: USA

Full name of joint inventor: Wayne G. Renken

Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Residence: 5928 Kyburz Place

San Jose, CA 95120

Post Office Address: same as above

Citizenship: USA



## DECLARATION FOR PATENT APPLICATION

Below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below adjacent to my name.

I believe I am an original, first and joint inventor of subject matter (process, machine, manufacture, or composition of matter, or an improvement thereof) which is claimed and for which a patent is sought by way of the application entitled

## SENSOR POSITIONING SYSTEMS AND METHODS

which was filed on **October 16, 2003** as Application Serial No. **10/688,300**.

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims.

I acknowledge the duty to disclose information, which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I declare that all statements made herein of my own knowledge are true, all statements made herein on information and belief are believed to be true, and all statements made herein are made with the knowledge that whoever, in any matter within the jurisdiction of the Patent and Trademark Office, knowingly and willfully falsifies, conceals, or covers up by any trick, scheme, or device a material fact, or makes any false, fictitious or fraudulent statements or representations, or makes or uses any false writing or document knowing the same to contain any false, fictitious or fraudulent statement or entry, shall be subject to the penalties including fine or imprisonment or both as set forth under 18 U.S.C. 1001, and that violations of this paragraph may jeopardize the validity of the application or this document, or the validity or enforceability of any patent, trademark registration, or certificate resulting therefrom.

Full name of joint inventor:

Mei H. Sun

Inventor's Signature:

Date:

2/17/04

Residence:

1059 Eastwood Drive  
Los Altos, CA 94024

Post Office Address:

same as above

Citizenship:

USA

Full name of joint inventor:

Richard Schwaninger

Inventor's Signature:

Date:

Residence:

5080 Rigatti Circle  
Pleasanton, CA 94588

Post Office Address:

same as above

Citizenship:

USA

Full name of joint inventor:

Wayne G. Renken

Inventor's Signature:

Date:

2/27/04

Residence:

5928 Kyburz Place  
San Jose, CA 95120

Post Office Address:

same as above

Citizenship:

USA



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Sun et al.  
Title: Sensor Positioning Systems and Methods  
Application No.: 10/688,300 Filing Date: October 16, 2003  
Examiner: Unknown Group Art Unit: 2858  
Docket No.: SENS.009US0 Conf. No.: 9197

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**POWER OF ATTORNEY BY ASSIGNEE OF ENTIRE INTEREST**

Sir:

The above-identified assignee, a California corporation, hereby revokes all powers of attorney previously given and appoints the attorney(s) and/or agent(s) identified by the following Customer Number to prosecute the above-identified application and to transact all business in the United States Patent and Trademark Office in connection therewith:

**Customer Number 36257**

Please direct all telephone calls to:

Gerald P. Parsons  
Telephone No.: (415) 318-1160  
Fax No.: (415) 693-0194

**ASSIGNEE CERTIFICATION UNDER 37 CFR 3.73(B)**

The undersigned representative of the above-identified assignee certifies that the above-identified assignee is the assignee of the entire right, title and interest in the above-

Attorney Docket No.: SENS.009US0

Application No.: 10/688,300

identified patent application by virtue of a chain of title from the inventor(s) of the above-identified patent application to the above-identified assignee as shown below:

From: Mei H. Sun, Richard Schwaninger, and Wayne G. Renken To SensArray Corporation for which a copy thereof is attached.

The undersigned (whose title is supplied below) is empowered to sign this certificate on behalf of the above-identified assignee.

2/17/04  
Date

Mei H SUN  
Name: [Signature]  
Title: VP of Sensor engineering